

APPLICATION NOTE

IAR Example with Execution in External Flash Using MSPI XIP Mode

A-SOCAP3-ANGA05EN v1.1



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Revision History

Revision	Date	Description		
1.0	April 11, 2022	Initial release		
1.1	January 3, 2023	Updated document part number		

Reference Documents

Document ID	Description

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Introduction

This release of the Apollo3 SDK provides two new examples that can be use to demonstrate a work flow for installing and executing a portion of customer code from an external Flash device using the Apollo3 MSPI in XIP mode. These examples are in:

- /boards/apollo3_eb/examples/mspi_flash_loader
- /boards/apollo3_eb/examples/mspi_prime

This application note walks the reader through the steps required to produce an example with code located in both internal and external flash, then split the resulting binary into two binaries:

- mspi_prime_internal is the binary loaded into the Apollo3 internal flash
- mspi_prime_external is the binary loaded into the external flash and accessed over MSPI XIP

1.1 Assumptions

This document assumes the following:

Cygwin or equivalent with python3 is installed in user's environment



IAR Example with Execution in External Flash Using MSPI XIP Mode

Use the following procedure:

- 1. Change directory to /boards/apollo3_eb/examples/mspi_prime.
- 2. Copy the **mspi_prime.icf** file their down into the **/iar** directory.

NOTE: The SDK release builder populates a default **mspi_prime.icf** file. This file does not relocate the **prime.o** object into the external flash. It is instructive to compare these two files to note the differences.

- 3. Open IAR and rebuild the **mspi_prime** example with the new ICF.
- 4. Check the **/iar/bin/mspi_prime.map** file to make sure the **prime.o .text** segment is located in the external flash address range as follows.

NOTE: that this example only relocates the **.text** segment of the **prime.c** program. It is recommended at this time that **.rodata** be left in internal flash.

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6		6 P C	1 🛗 🏂 🔍	ج 🖫 🖓	i 🗐 🗐 🗐 🖉 🖉 🖉 🖉 🖉 🗐	BC
mspi_	prime.map 🔀					
0.6	.text	ro code	0x0000409c	0xa	cexit.o [7]	
07	.text	ro code	0x000040a8	0x14	exit.o [8]	
08	.text	ro code	0x000040bc	0xc	cstartup_M.o [7]	
9	.text	ro code	0x000040c8	0x8	startup_iar.o [1]	
LO	.rodata	const	0x000040d0	0x4	am_hal_cachectrl.o [5]	
11	.rodata	const	0x000040d4	0x0	zero_init3.0 [7]	
12	.rodata	const	0x000040d4	0x0	packbits_init_single.o [7]	
.3	Initializer bytes	const _	0x00004044	0xc4	<for p3-1=""></for>	
4		L	0x00004198	0x4098	J	
16	P1":			0x64		
.7	PRIME_CORE		0x04000000	0x64	<block></block>	
.8	.text	ro code	0x04000000	0x64	prime.o [1]	
9		-	0x04000064	0x64		
1	"A1":			0x1000		
2	.noinit	uninit	0x10000000	0x1000	startup iar.o [1]	
3		-	0x10001000	0x1000		
4						
5	"P3", part 1 of 2:			0x15c		
6	P3-1		0x10001000	0x15c	<init block=""></init>	
27	.data	inited	0x10001000	0x54	am devices fireball.o [1]	
8	.data	inited	0x10001054	0x6c	am devices mspi flash.o [1]	

5. Use the linux **data duplicator** or **dd** command to separate the /iar/bin/mspi_prime.bin into the internal and external segments (below). The first **dd** command separates the internal flash segment of the **mspi_prime** example. The second **dd** command separates the external flash segment of the **mspi_prime** example.

NOTE: The value 16792 is equivalent to the 0x4198 (see above) and is the ending location of the **mspi_prime** internal flash segment and 67108864 is 0x04000000.



- 6. Copy the mspi_prime_external.bin to the /boards/apollo3_eb/examples/mspi_flash_loader directory.
- 7. Copy the IAR binary for the **mspi_flash_loader** example from the **/iar/bin** directory to the parent directory.
- 8. Create the loader program using the python script (**mspi_loader_binary_combiner.py**) as follows:



9. Use the J-Link tools or IAR to run the **out.bin** binary. This will load the **mspi_prime** external flash segment as follows:

SEGGER J-Link SWO Viewer V6.22d			— — ×			
<u>F</u> ile <u>E</u> dit <u>H</u> elp						
Data from stimulus port(s): 31						
☐ Stay on top						
Apollo3 MSPI Example Fireball found, ID is 0x7710. Fireball Version is 0x1. Valid Patched information found Bin Address in internal flash = 0x46dc Bin Install Address in external flash = 0x4000000 Bin Size = 0x64 Scrambling is Disabled Initiating erase of required sectors of Flash Device! Erasing Sector 0 Erase Done! Writing image to External Flash Device! Writing image in External Flash Device! MSPI Flash Loaded						
Device: AMAPH1KK-KBR	CPUFreq: 48042 kHz	SWOFreq: 1000 kHz	471 bytes			

10. Use the J-Link tools to load and run the **/boards/apollo3_eb/examples/mspi_prime/ mspi_prime_internal.bin** on the target. The output to the UARTO (115200bps) should appear as follows:





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